

深圳建扬技术有限公司 样 品 承 认 书

| 项 | 目 | 名 | 称: | TC-33 221 |
|---|---|---|----|-----------------|
| 样 | 品 | 名 | 称: | TWGMC/台湾迪嘉 |
| 样 | 品 | 规 | 格 | MMBT3904 SOT-23 |
| 物 | 料 | 编 | 码: | 45PNPN2N3904 |
| 日 | | | 期: | 2023年7月10号 |

| | | | | 世和夕 |
|---|---------|--------------|---------|----------|
| | 供应商 | 制定 | 审核 | 批准 |
| | N/EZ IN | 陈丽萍 | 林吟华 | 在是教 |
| | 74 +7. | 资材核准 | 研发核准人 | 品质核准 |
| | 建扬 | あ 周俊娟 | 2023-10 | on some |
| - | | | | 1, 1, 1, |

1. 此样品承认书一式三份(含样品),其他情况以通知为准,

2. 承认书一经签署即按此承认标准做货,不得更改;

| 供 | 应 | 商 | 名 | 称 | | 深 | 圳 | 市 | 瑞 | 利 | 昇 | 科 | 技 | 有 | 限 | 公 | 司 |
|----|-------|--------|----------|-------|----------|-----|-------------|-----|------------|----------|----|----|----|----|-----|-----|--------|
| 由台 | £ TFI | 1 | 07 | 55-8 | 22 | 556 | 65 ∄ | 3线 | | | | | | | | | |
| | | | | | | | | | | | | | | | | | |
| 地 | | 址 . | <u>深</u> | 圳市 | | 田 | 区振 | 华路 | ~12 | 2号 | 海夕 | 小装 | 饰力 | 「夏 | A 座 | 6 杉 | K Z |
| 厂商 | 商资质 | 万: | | 0900° | 1 | | S0140 | 001 | | 其他 | | | | | | | |
| 送柱 | 生履 月 | Fi : 1 | 门首) | ク送ね | 兰 | Г | コー次 | 送样 | | $\Box =$ | 次误 | 杜 | | | | | |



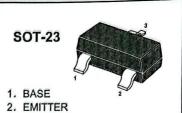
MMBT3904

TRANSISTOR (NPN)

FEATURES

- Epitaxial Planar Die Construction
- Complementary PNP Type Available (MMBT3906)
- Ideal for Medium Power Amplification and Switching

MARKING: 1AM



3. COLLECTOR

MAXIMUM RATINGS (Ta=25°C unless otherwise noted)

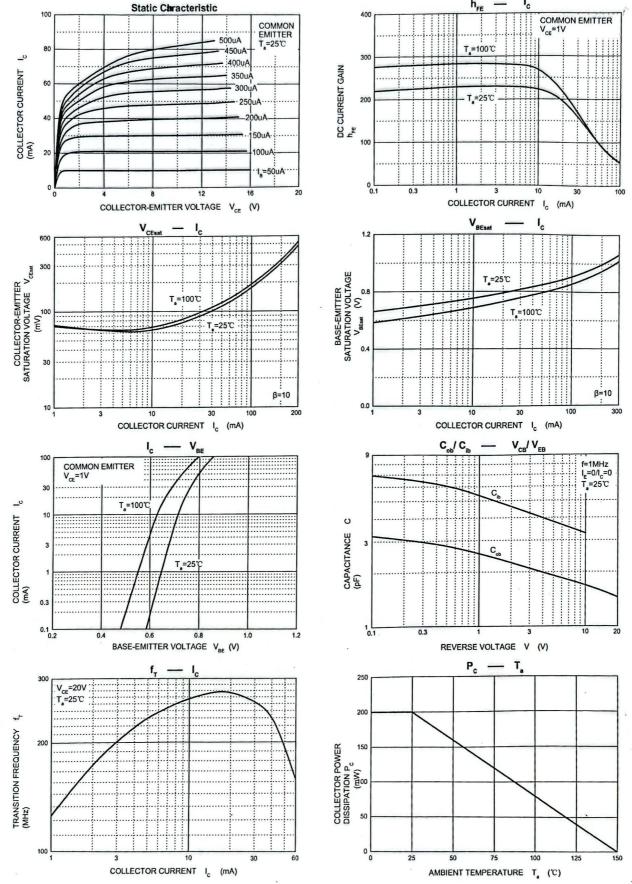
| Symbol | Parameter | Value | Unit |
|------------------|---|------------|------|
| V _{CBO} | Collector-Base Voltage | 6.0 | V |
| V _{CEO} | Collector-Emitter Voltage | 40 | V |
| V _{EBO} | Emitter-Base Voltage | 6 | V |
| Ic | Collector Current | 200 | mA |
| Pc | Total Device Dissipation | 200 | mW |
| $R_{\theta JA}$ | ThermalResistanceFromJunction toAmbient | 625 | °C/W |
| T _J | Junction Temperature | 150 | °C |
| T _{stg} | Storage Temperature | -55 ~ +150 | °C |

ELECTRICAL CHARACTERISTICS (Ta=25°C unless otherwise specified)

| Parameter | Symbol | Test conditions | Min | Max | Unit |
|--------------------------------------|----------------------|--|-------------|--|------|
| Collector-base breakdown voltage | V(BR)CBO | I _C = 10μΑ, I _E =0 | 60 | The State of the S | V |
| Collector-emitter breakdown voltage | V _{(BR)CEO} | I _C = 1mA, I _B =0 | 40 | | V |
| Emitter-base breakdown voltage | V _{(BR)EBO} | I _E =10μA, I _C =0 | 6 | | V |
| Collector cut-off current | Ісво | V _{CB} =60V, I _E =0 | | 0.1 | μΑ |
| Collector cut-off current | I _{CEX} | V _{CE} =30V, V _{BE(off)} =3V | | 50 | nA |
| Emitter cut-off current | I _{EBO} | V _{EB} =5V, I _C =0 | Rost can be | 0.1 | μΑ |
| | h _{FE(1)} | V _{CE} =1V, I _C =10mA | 100 | 300 | |
| DC current gain | h _{FE(2)} | V _{CE} =1V, I _C = 50mA | 60 | | |
| 20 canoni gam | h _{FE(3)} | V _{CE} =1V, I _C = 100mA | 30 | | |
| Collector-emitter saturation voltage | V _{CE(sat)} | I _C =50mA, I _B = 5mA | | 0.3 | V |
| Base-emitter saturation voltage | V _{BE(sat)} | I _C = 50mA, I _B = 5mA | | 0.95 | V |
| Transition frequency | f _T | V _{CE} =20V, I _C =10mA, f=100MHz | 300 | | MHz |
| Delay Time | ta | V _{CC} =3V, V _{BE} =-0.5V | | 35 | nS |
| Rise Time | tr | I _C =10mA, I _{B1} =-I _{B2} =1.0mA | | 35 | 'nS |
| Storage Time | ts | V _{cc} =3V, I _c =10mA, | | 200 | nS |
| Fall Time | tr | I _{B1} =-I _{B2} =1mA | | 50 | nS |









PACKAGE OUTLINE

Plastic surface mounted package; 3 leads

SOT-23

